



Bauteilvorbereitung

Selektivlötsysteme

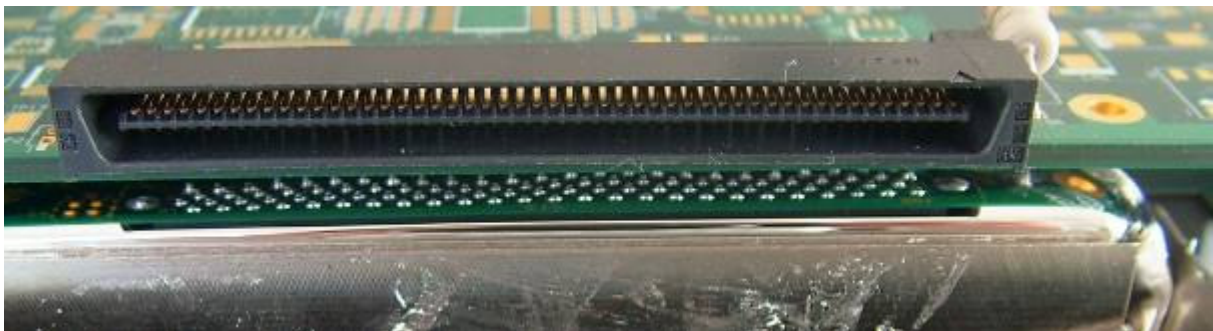
Sondermaschinen



Internet: <http://www.ebso.com>



SPA – R
Selective Solder Rework System
With unique „**Fast Remove**“ Pumpsystem



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- Display easy to operate
- Timer-Function
- Pump and Solder bath made of full Titanium best for lead free alloys
- On the fly – Wave height regulation
- Standby-Function to reduce process time
- Wide range of standard solder nozzles and customized nozzles
- Huge top space for very large boards
- Optional Laserpointer und XY – Table
- Optional Nitrogen Inert to reduce dross

Magnetic PCB-fixtures in different sizes,
for free positioning



Wide range of standard solder nozzles and customized nozzles



The solder pump system

The unique flat pump design with a superb „**Fast Remove**” system allows maintenance within minutes. Just an easy turn with the supplied tooling gives instant access to the pump and solder bath.



Technical Data

Power:	220 V (50/60 Hz) / 2 KW
Temperature:	0 – 400 °C
Solder Capacity:	ca. 20 kg
PCB size:	no Limits
Measurements:	400 (B) x 700 (L) x 250 (H) mm
Weight:	ca. 35 kg with empty solder pot

